

FIG.1A

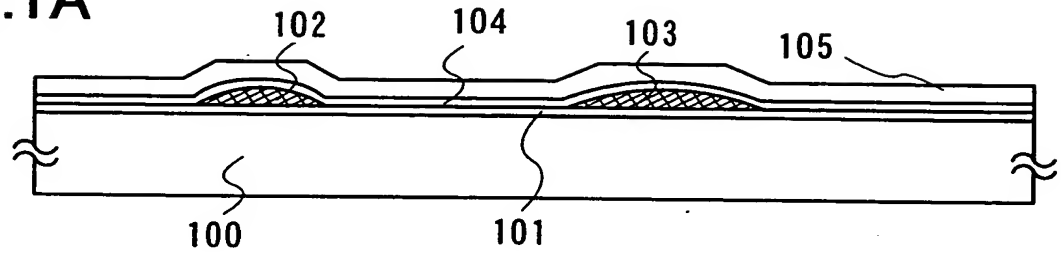


FIG.1B

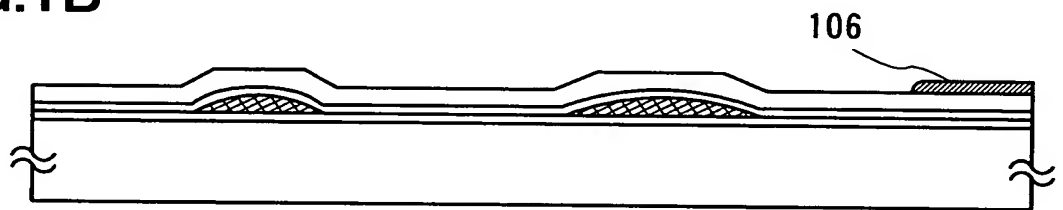


FIG.1C

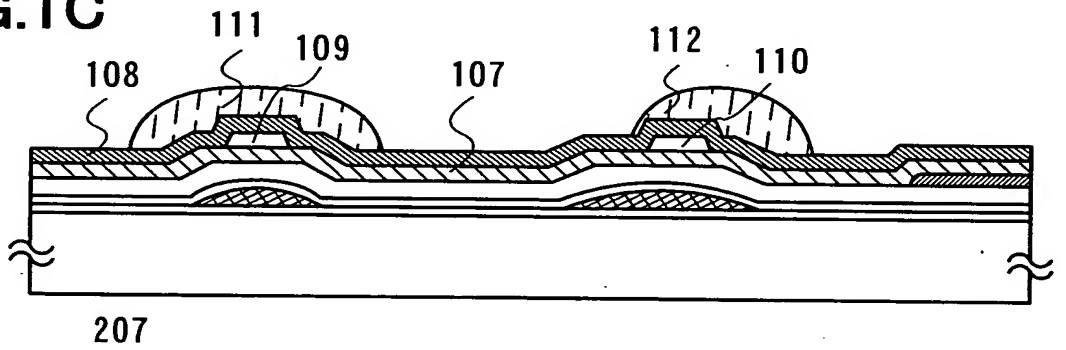


FIG.1D

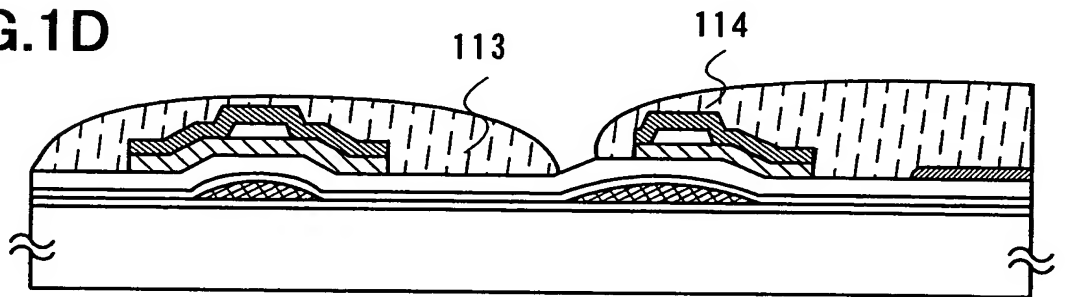


FIG.2A

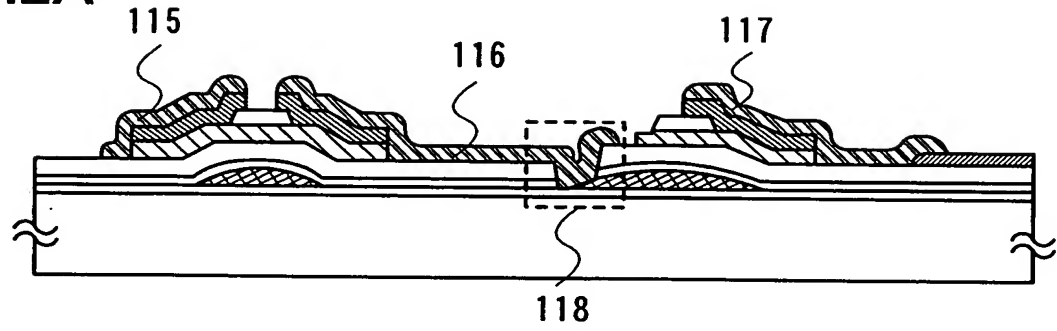


FIG.2B

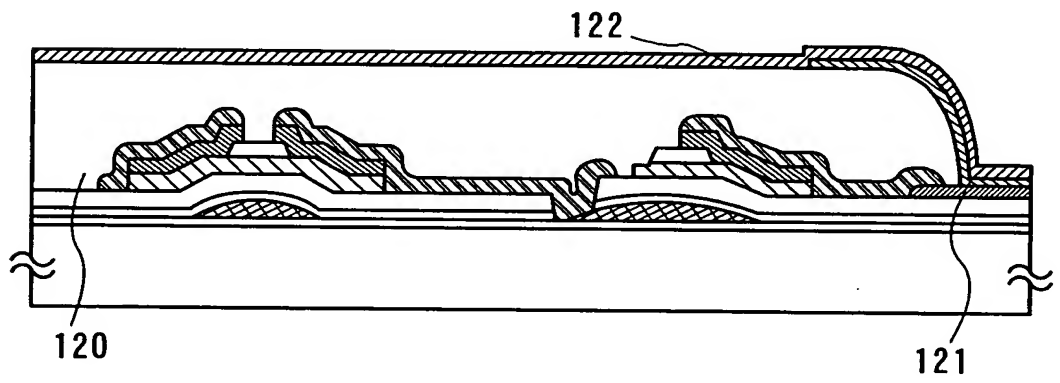


FIG.3A

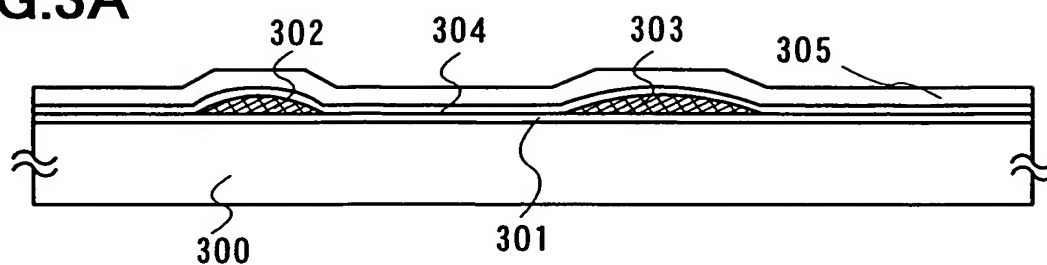


FIG.3B

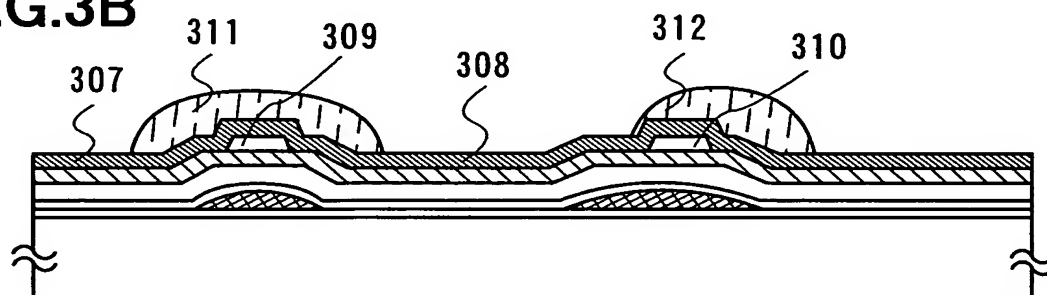


FIG.3C

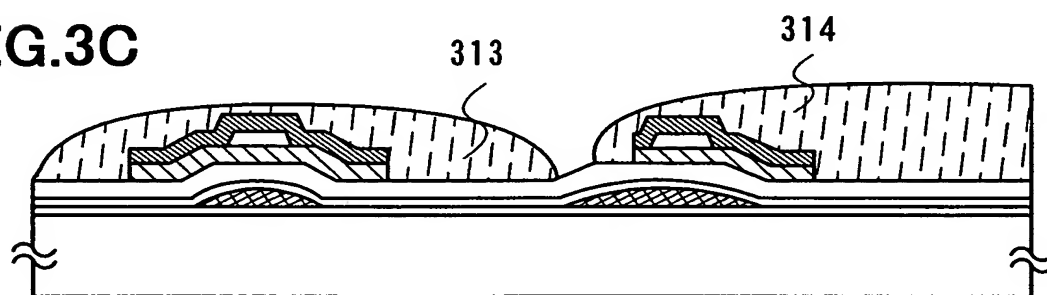


FIG.3D

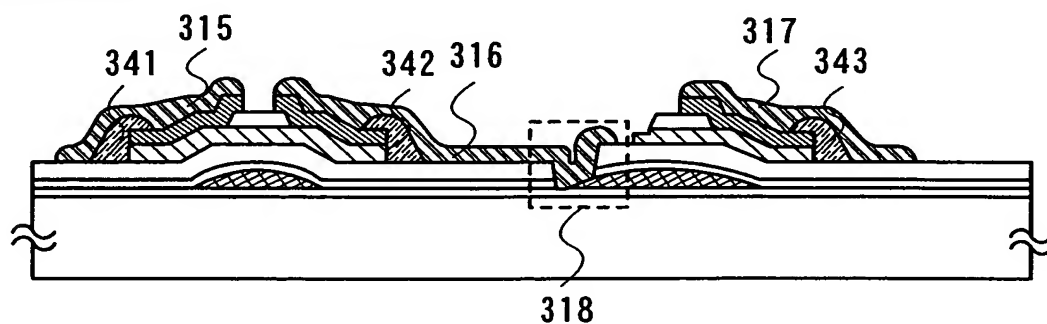


FIG.4A

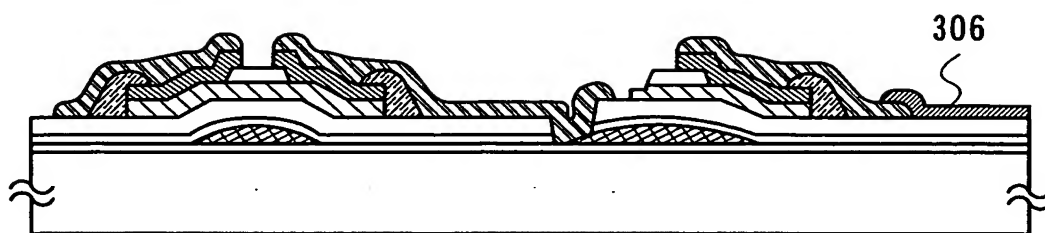


FIG.4B

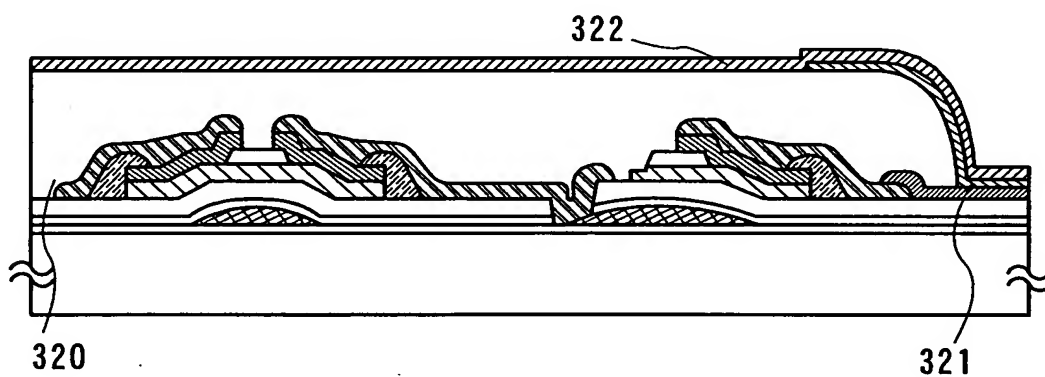


FIG.5A

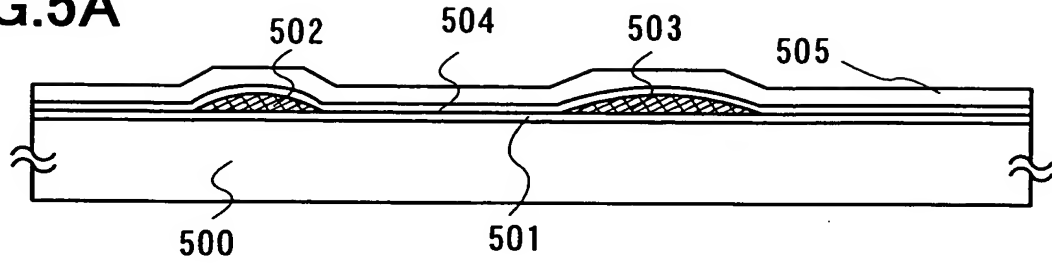


FIG.5B

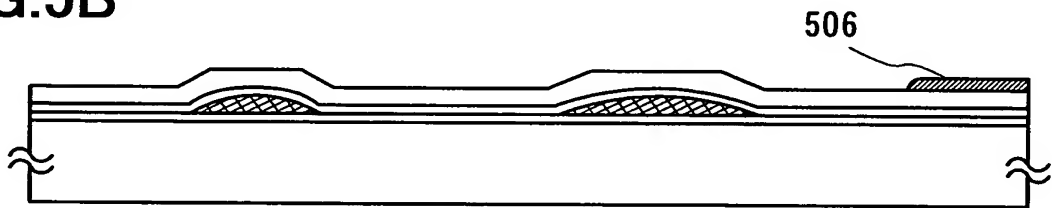


FIG.5C

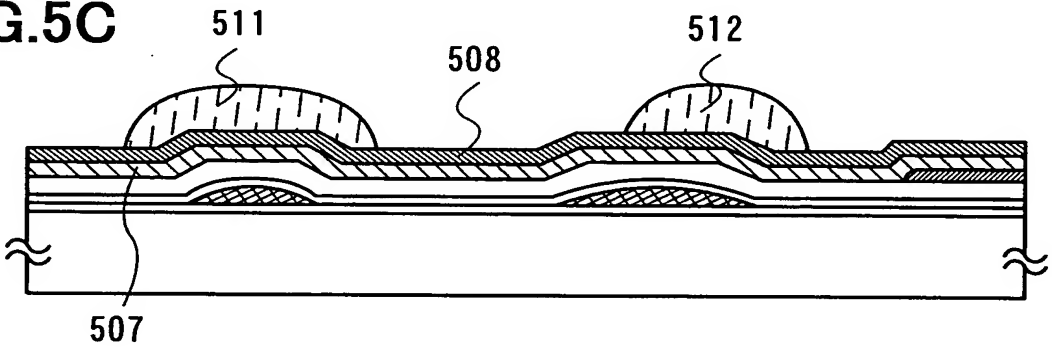


FIG.5D

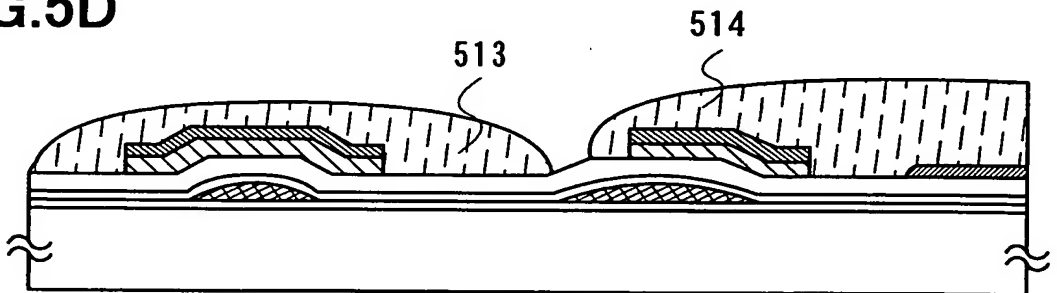
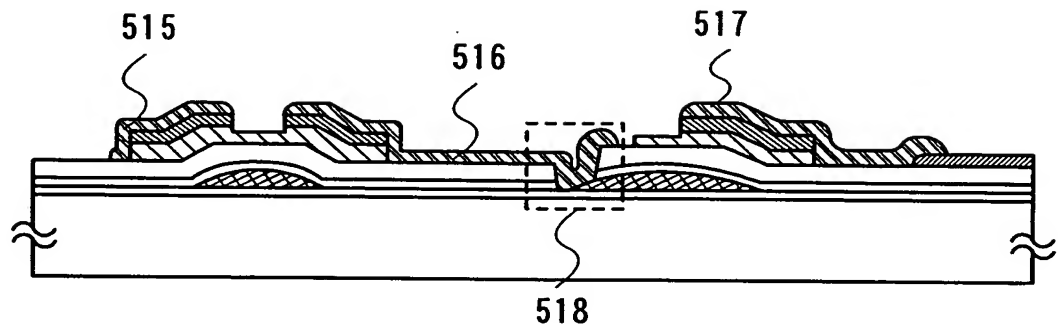
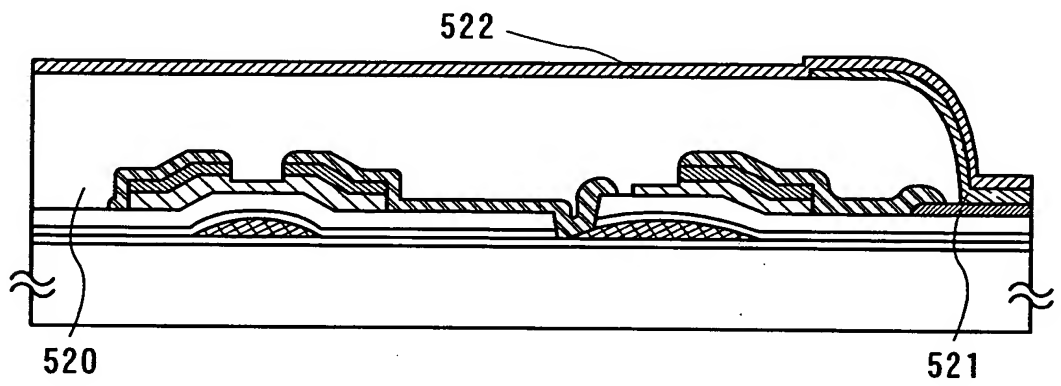


FIG.6A**FIG.6B**



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FIG.7A

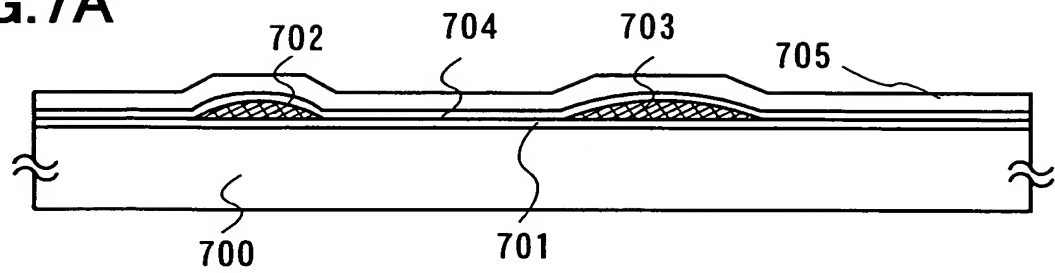


FIG.7B

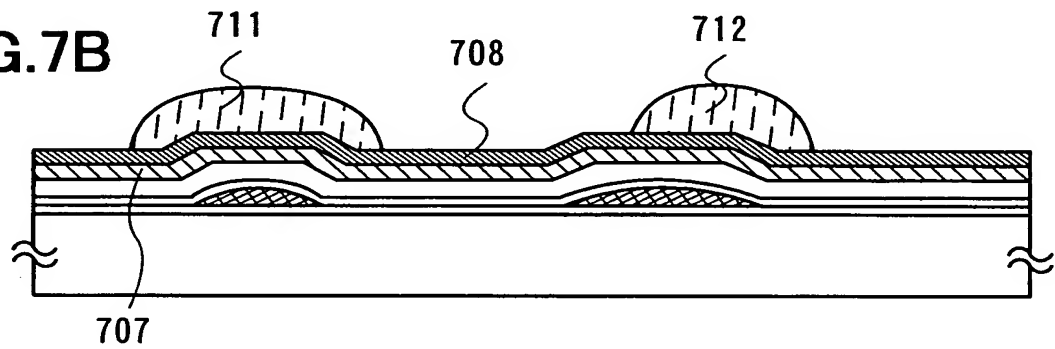


FIG.7C

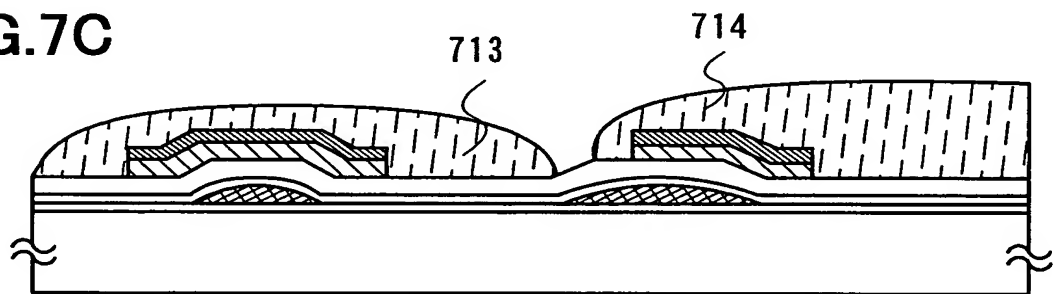


FIG.7D

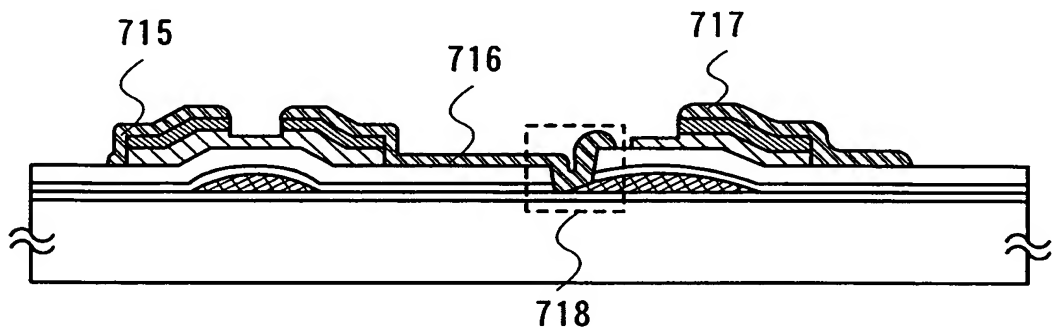


FIG.8A

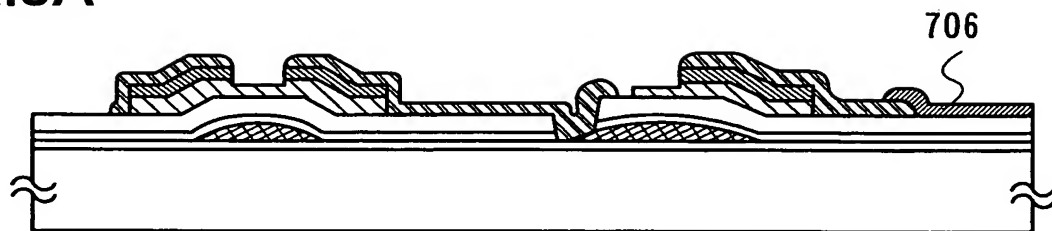


FIG.8B

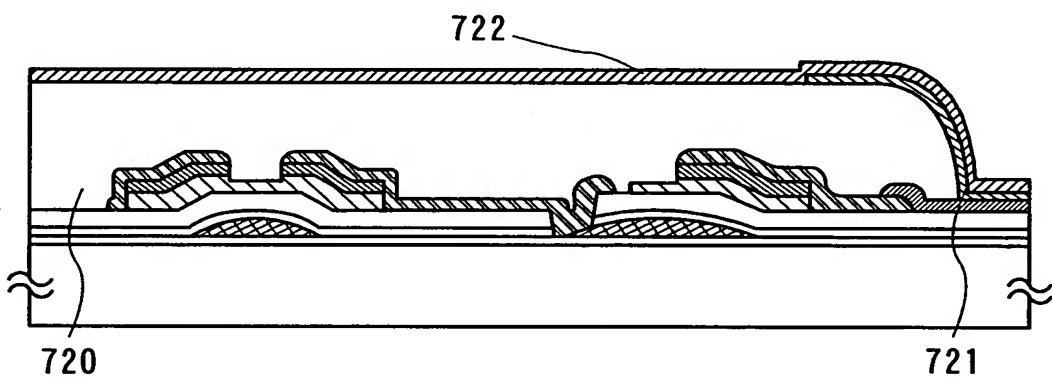


FIG.9A

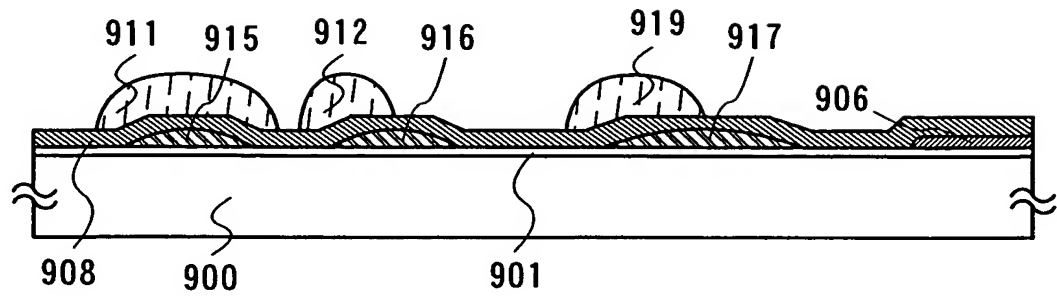


FIG.9B

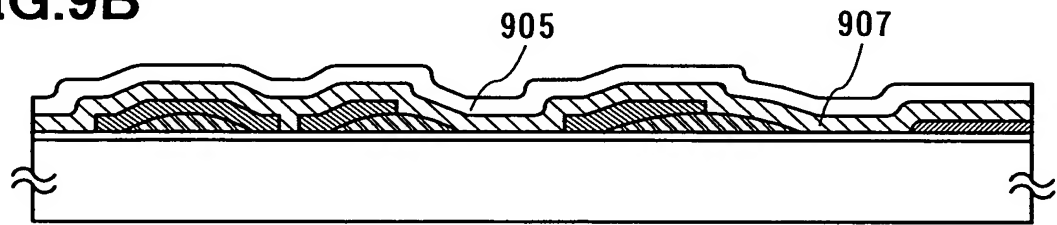


FIG.9C

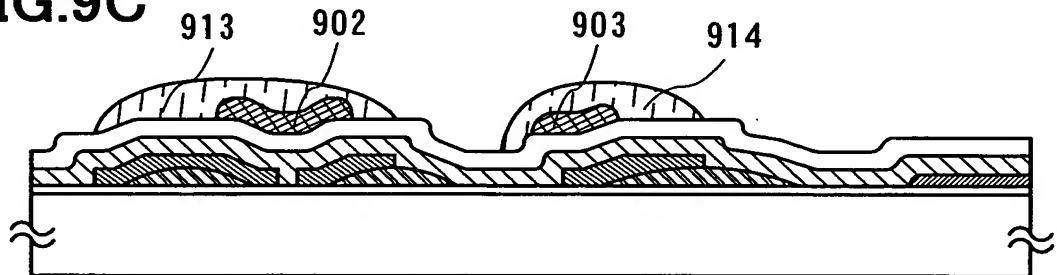


FIG.9D

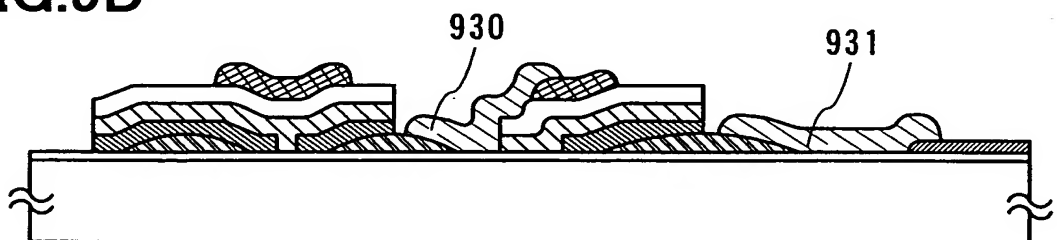


FIG.10

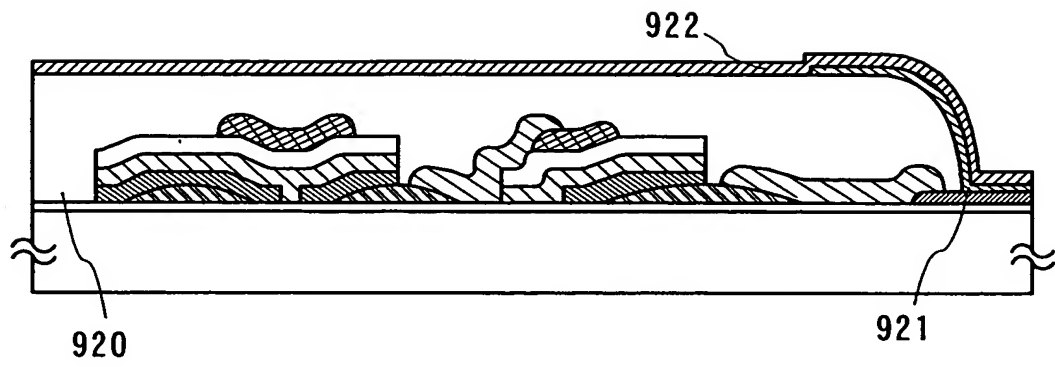


FIG.11A

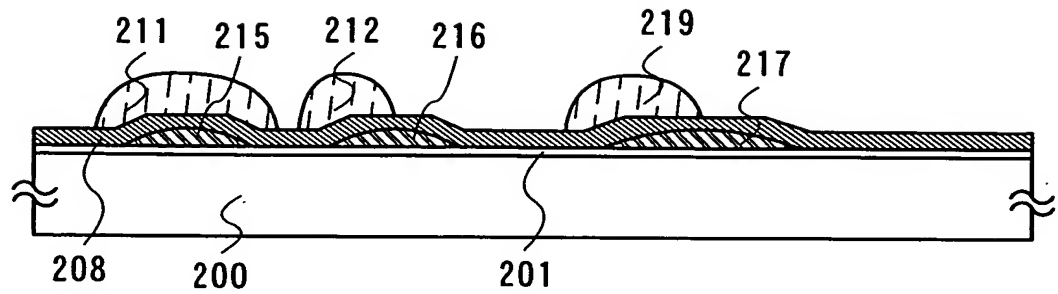


FIG.11B

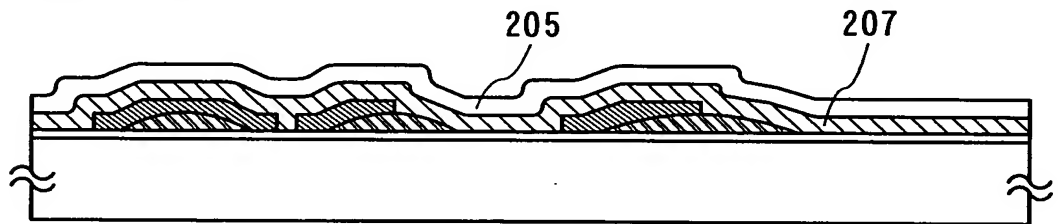


FIG.11C

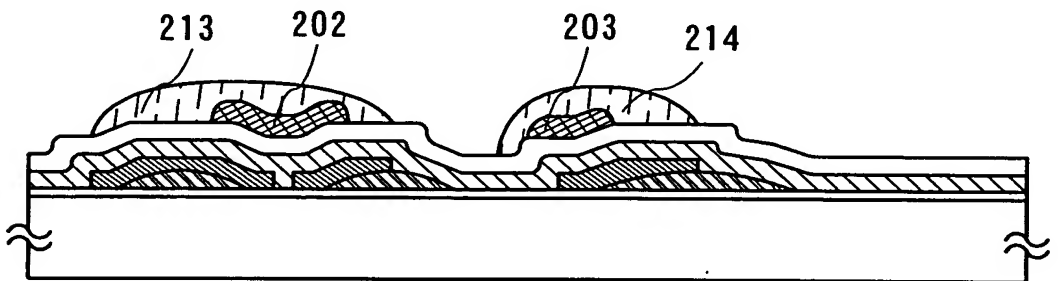


FIG.11D

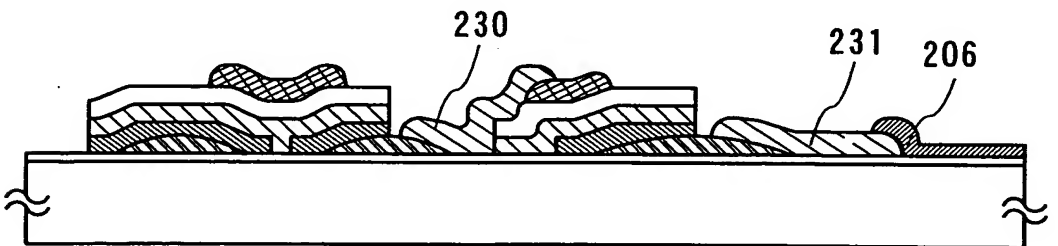
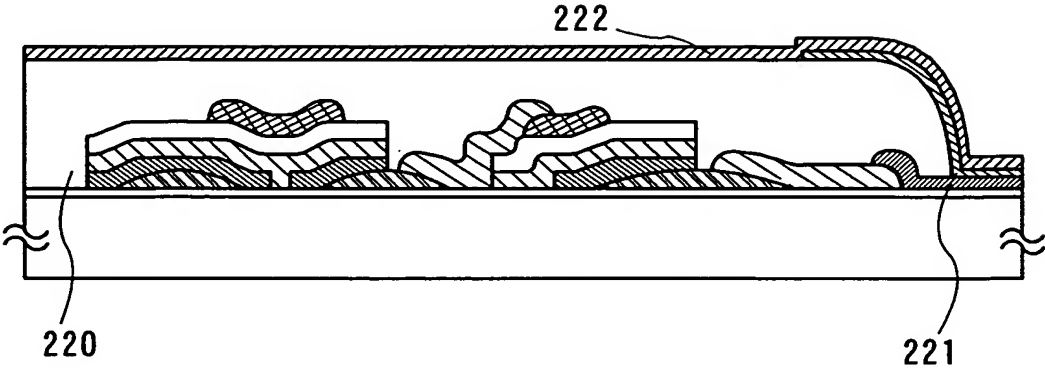


FIG.12



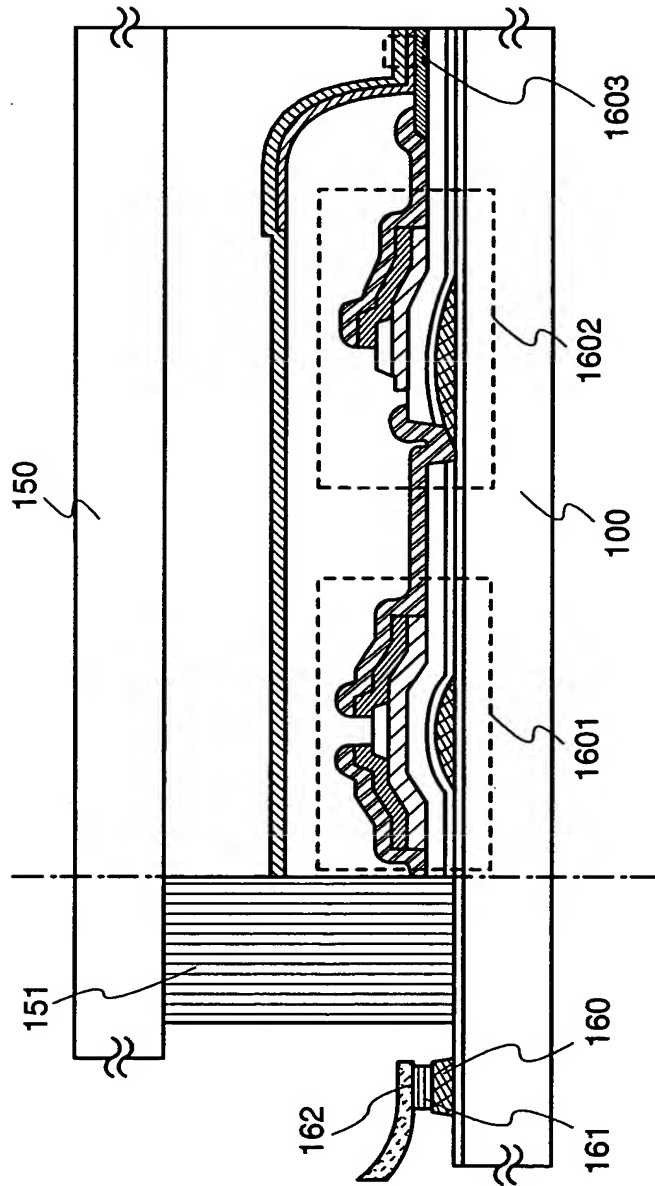


FIG.13

FIG.14A

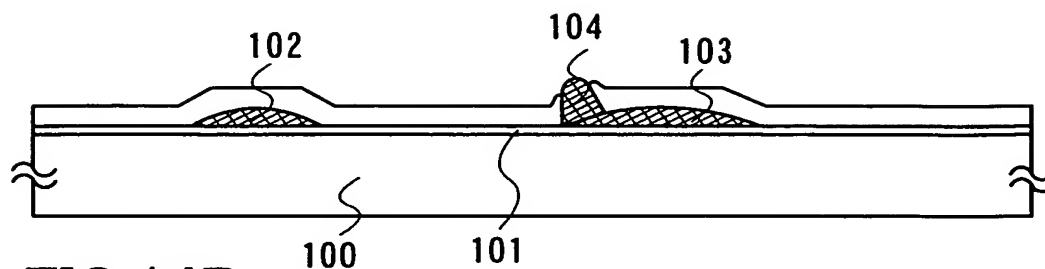


FIG.14B

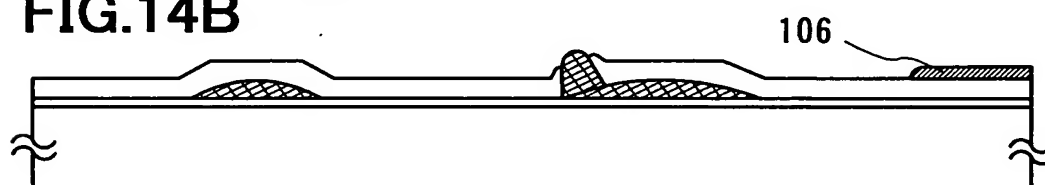


FIG.14C

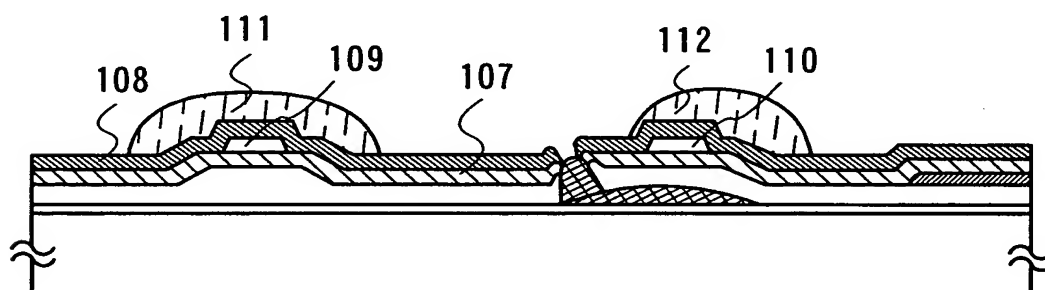


FIG.14D

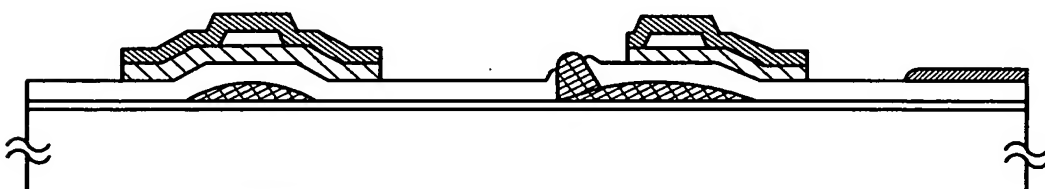


FIG.15A

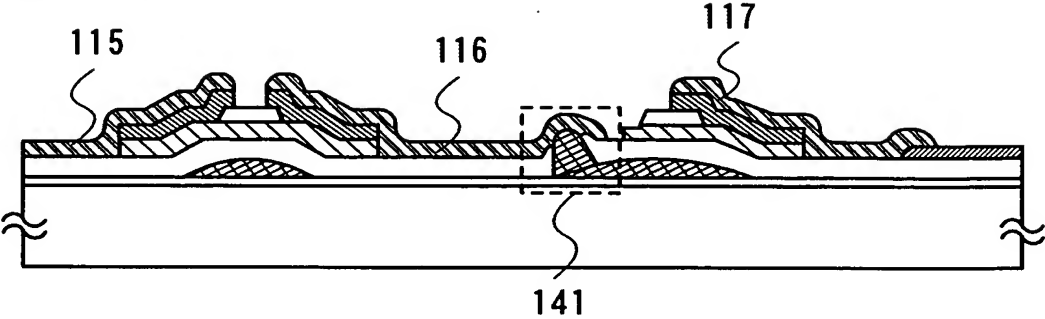
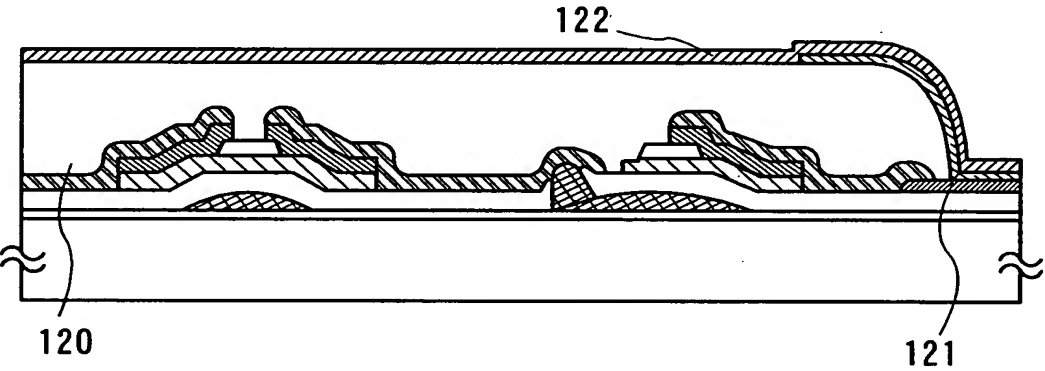


FIG.15B



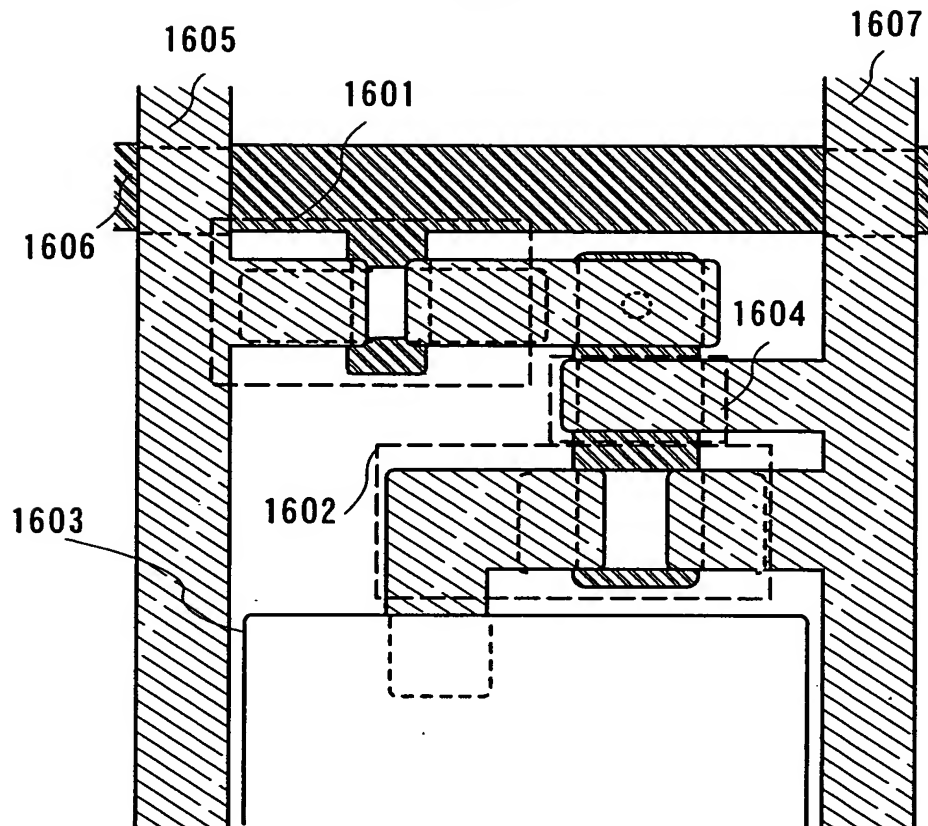


FIG.16A

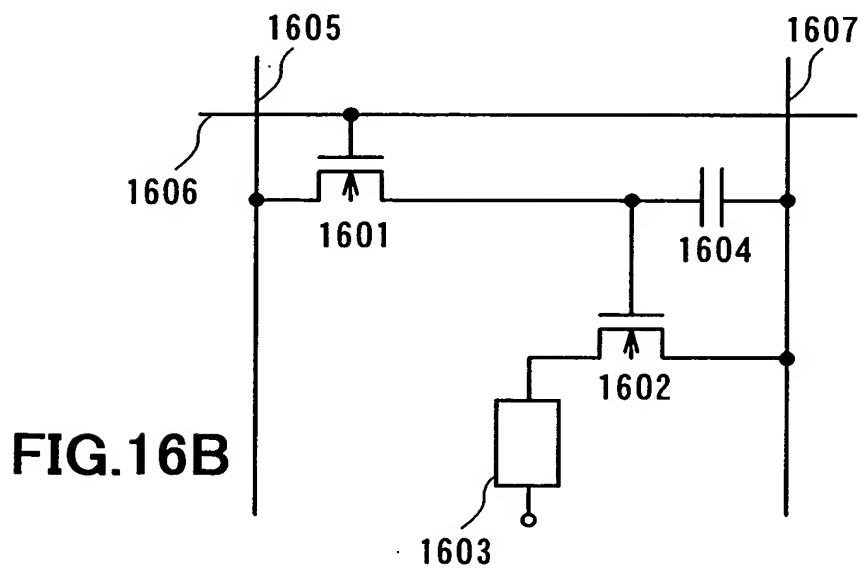


FIG.16B

FIG.17A

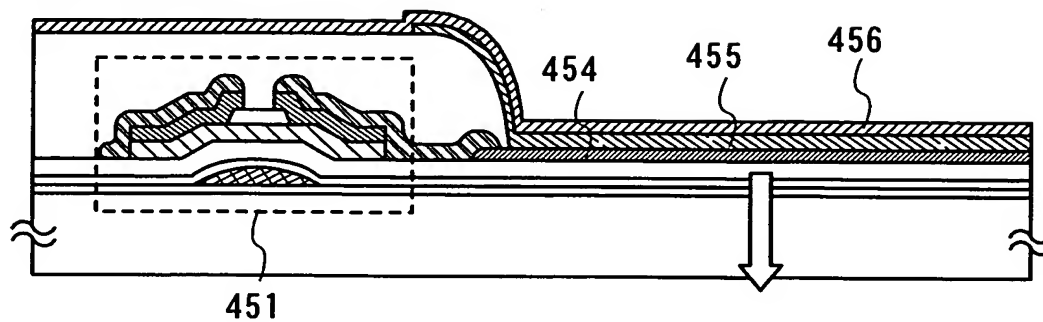


FIG.17B

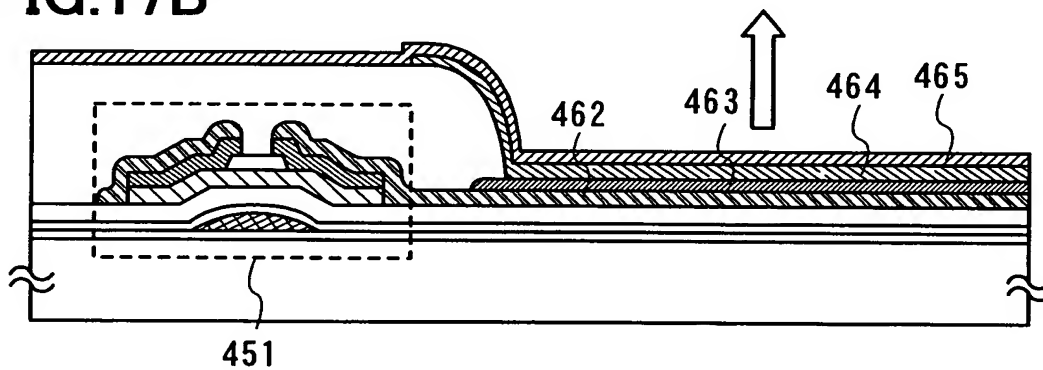
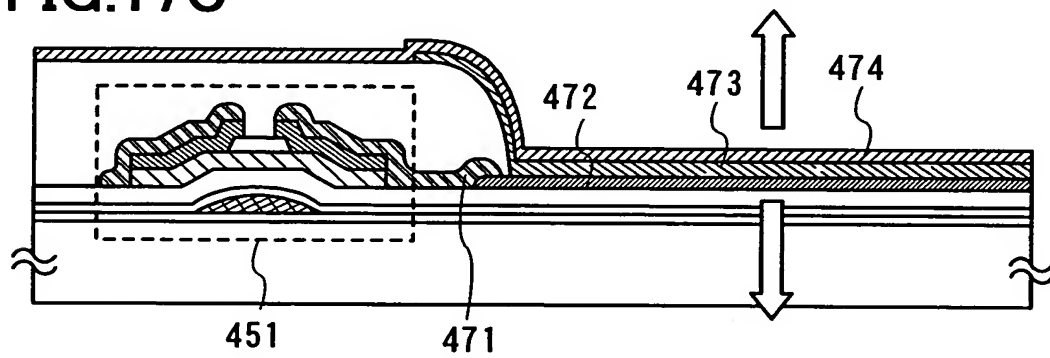


FIG.17C



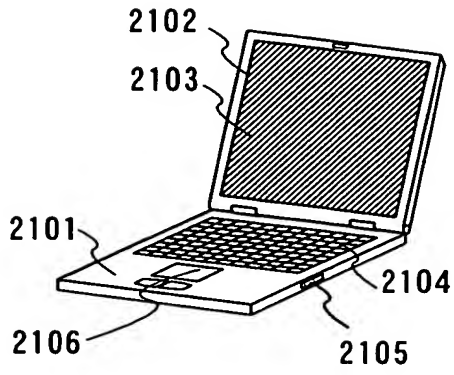


FIG. 18A

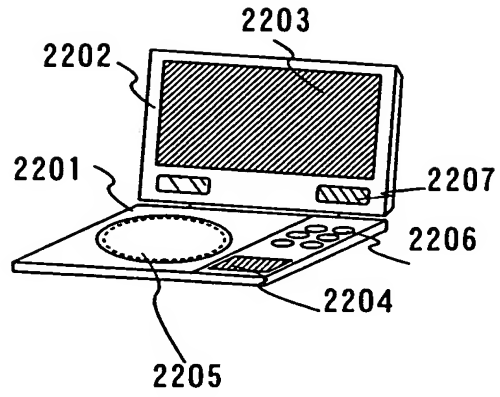


FIG. 18B

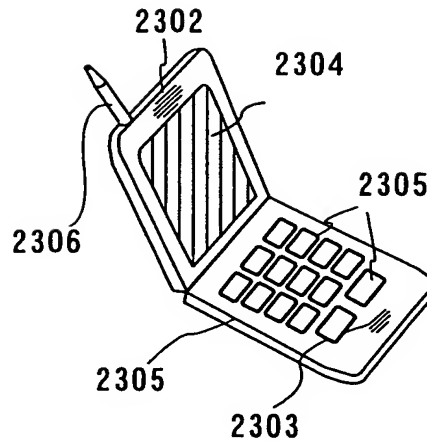


FIG. 18C

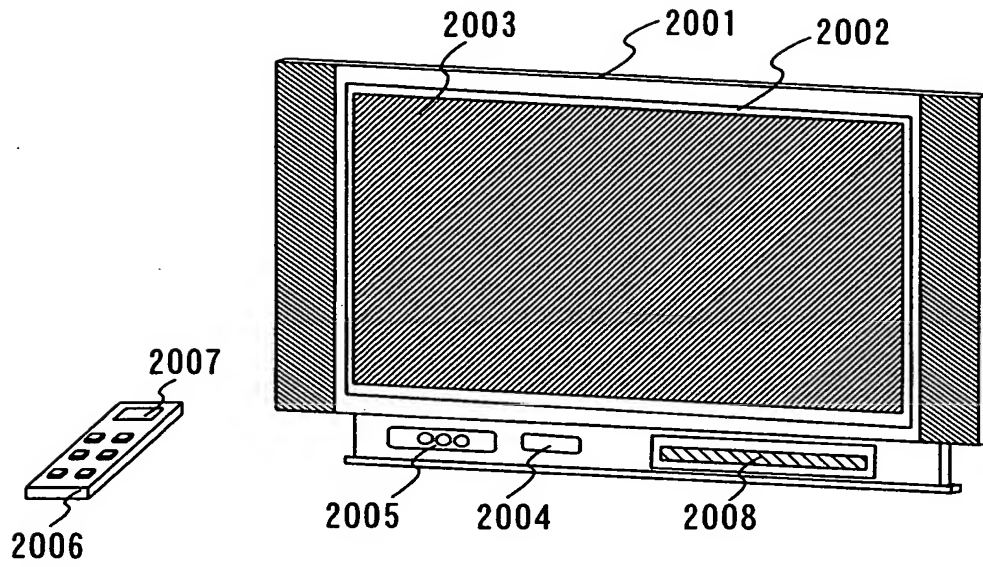
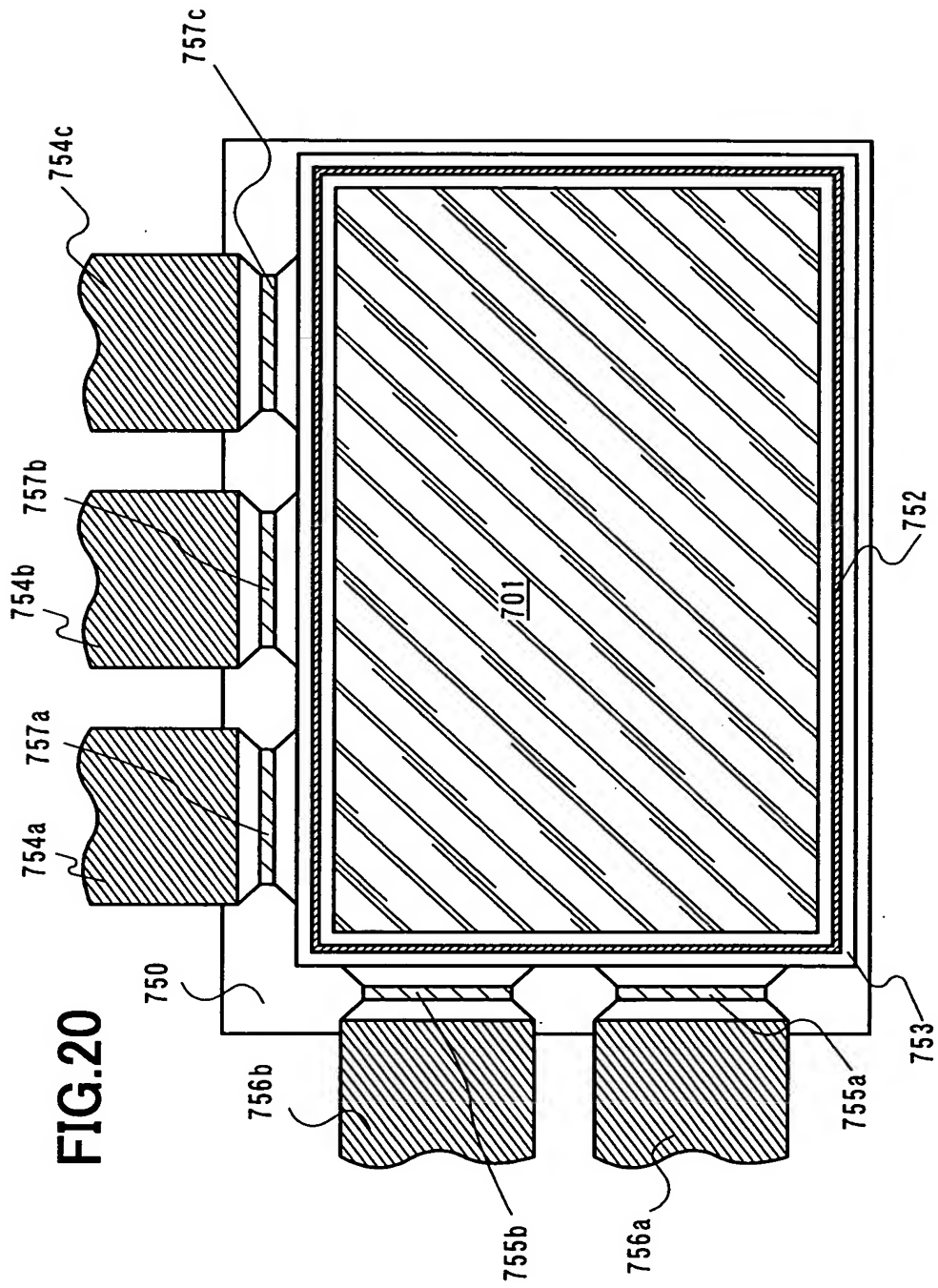


FIG. 19



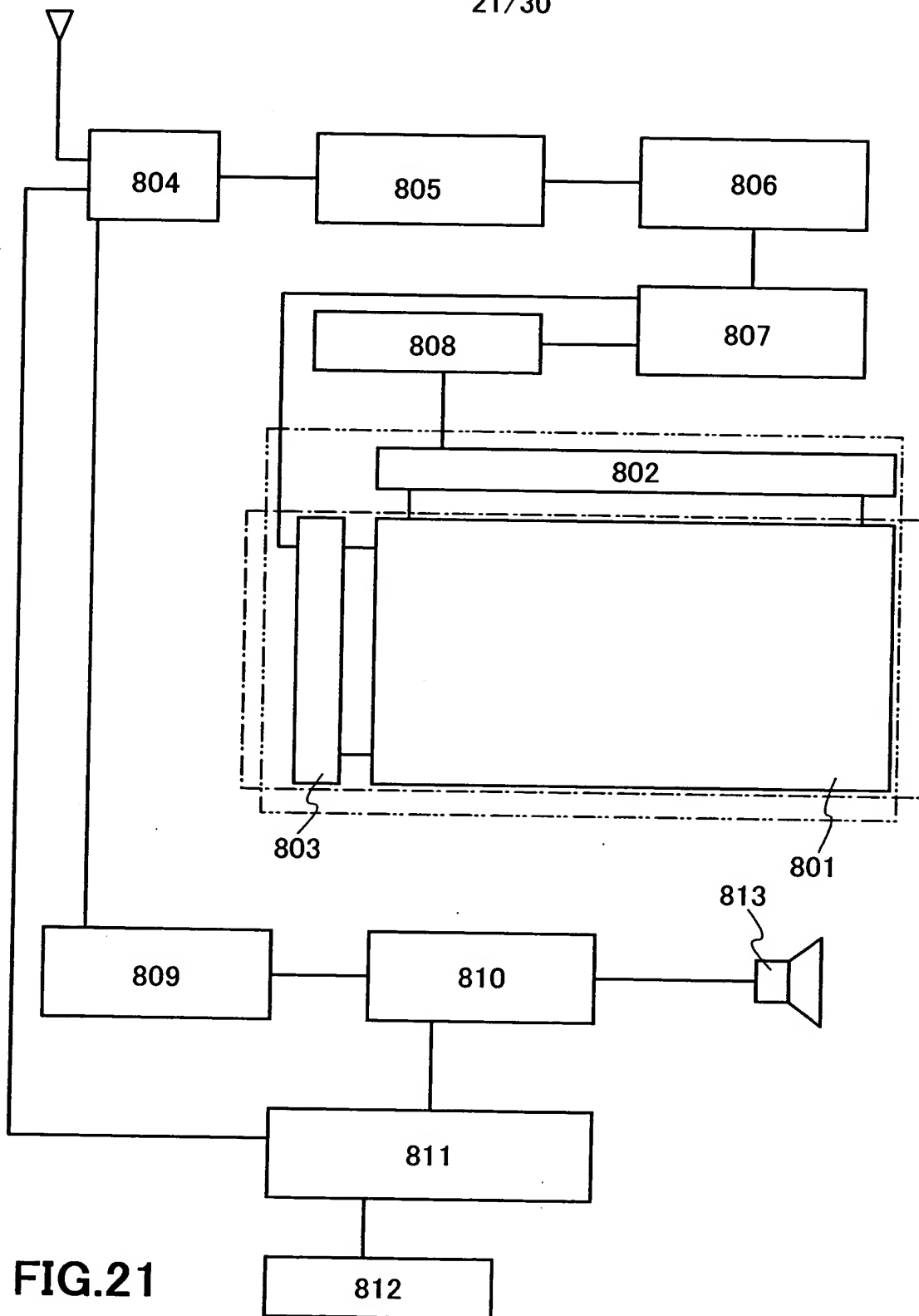
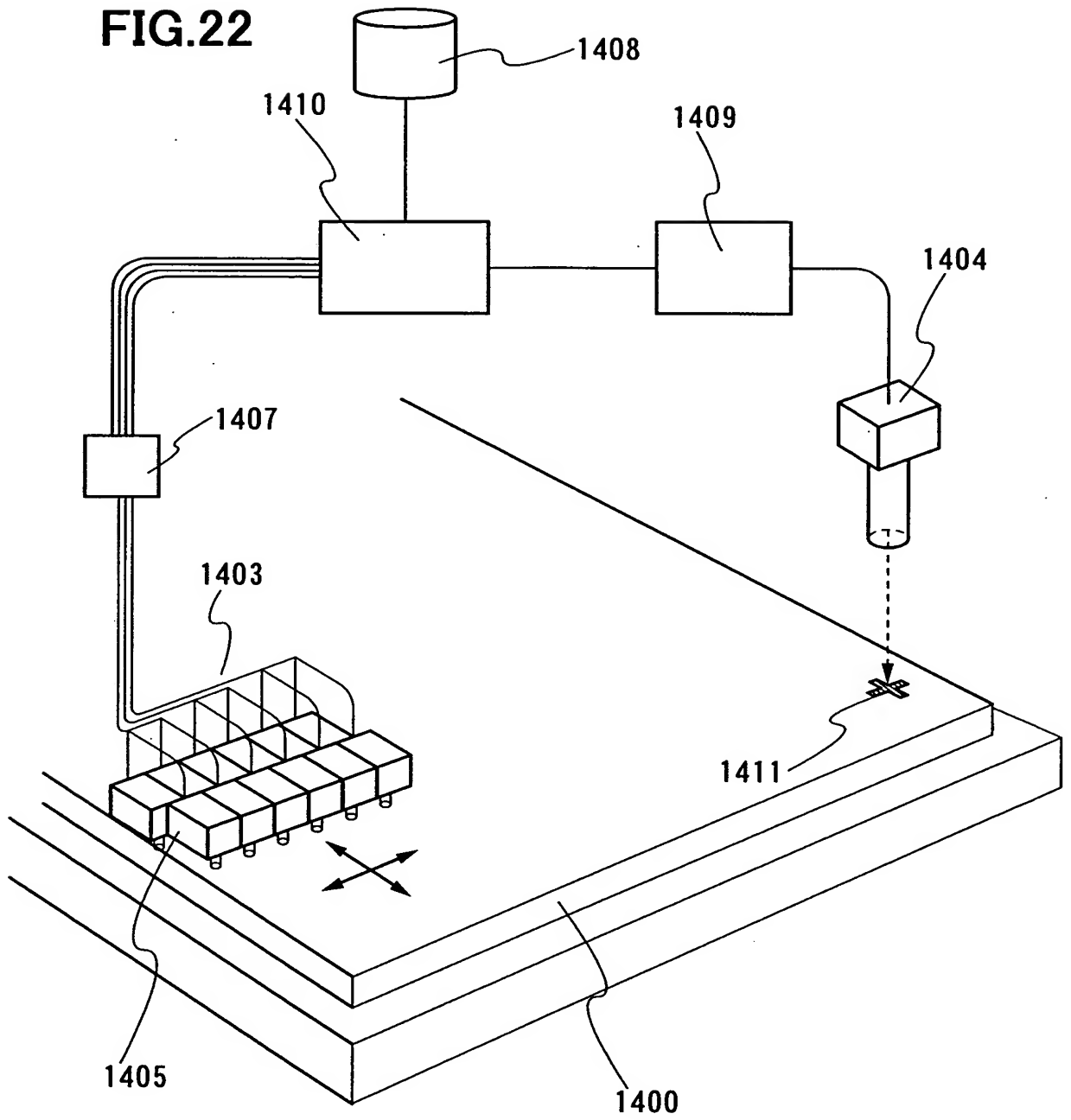
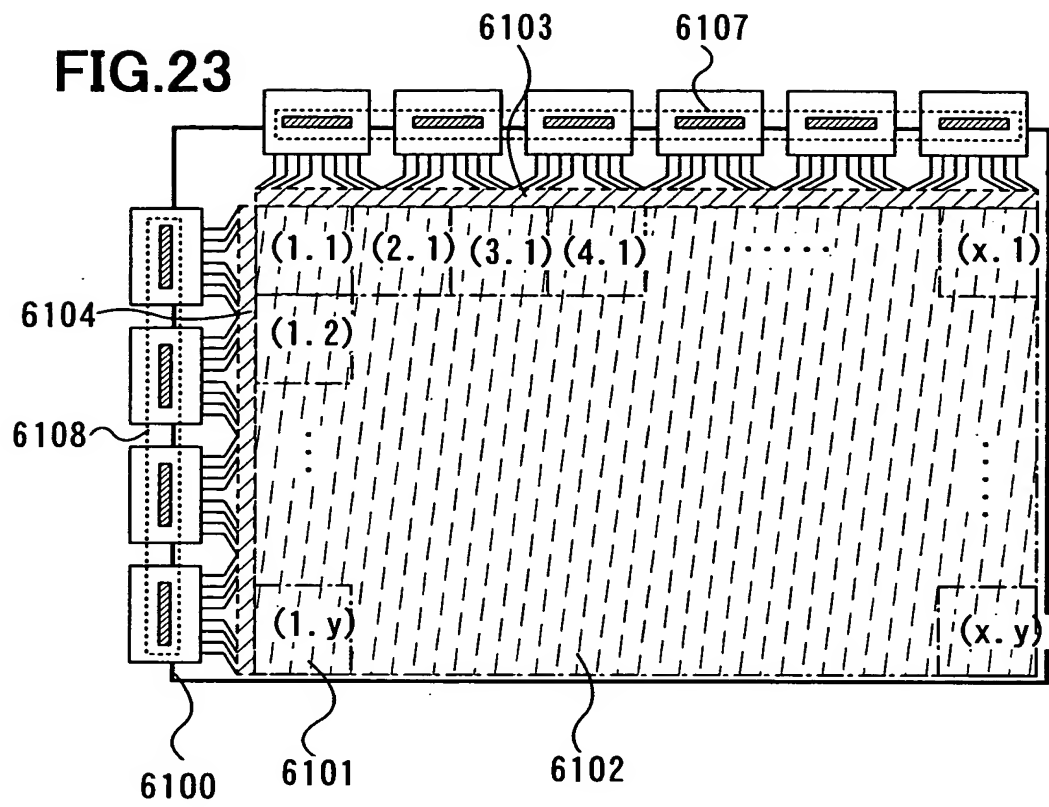


FIG. 21

FIG.22



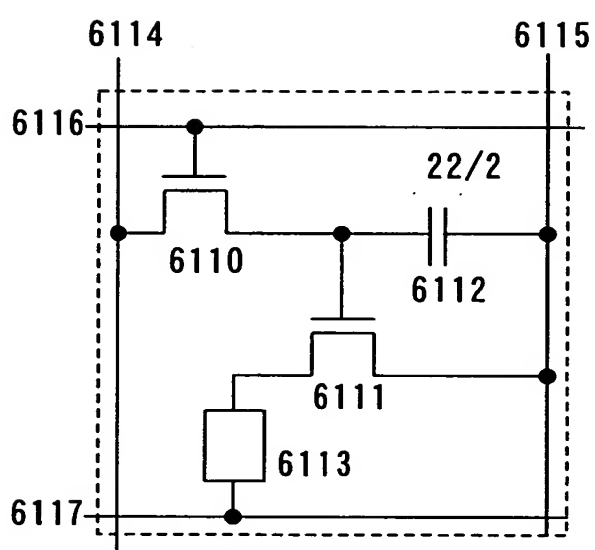


FIG. 24A

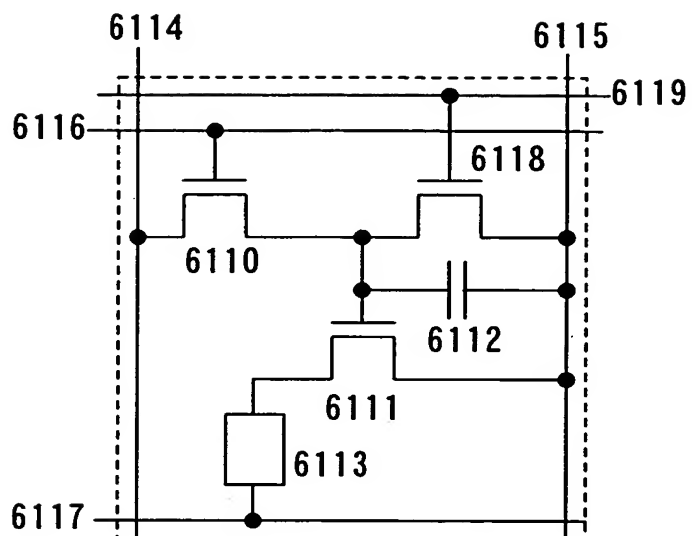


FIG. 24B

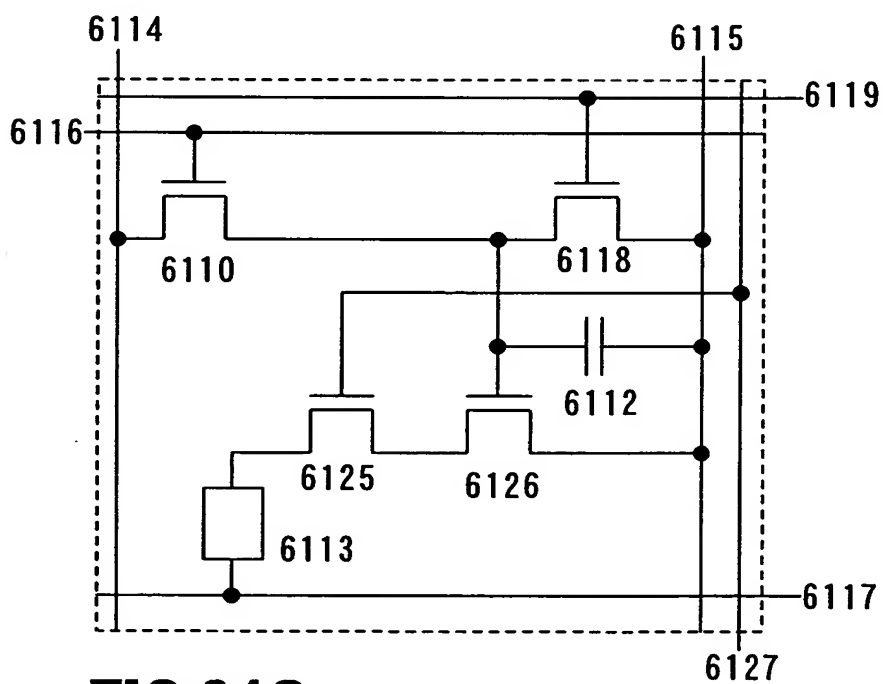


FIG. 24C

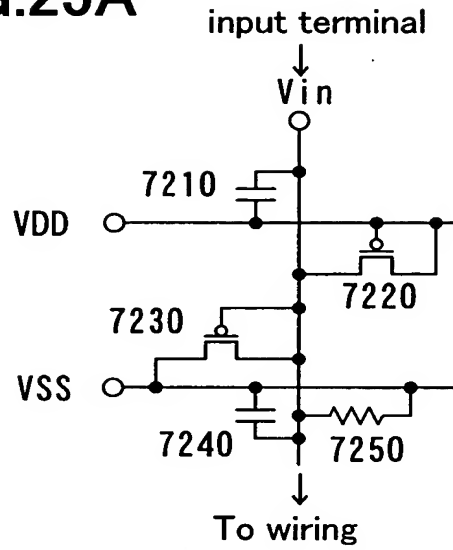
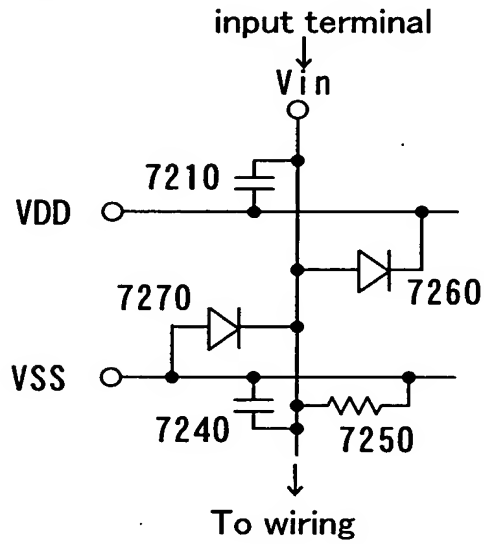
FIG.25A**FIG.25B**

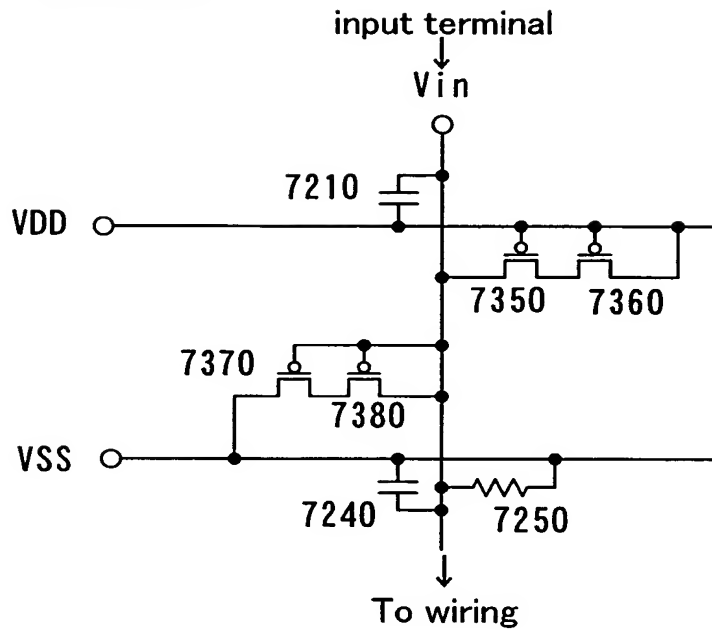
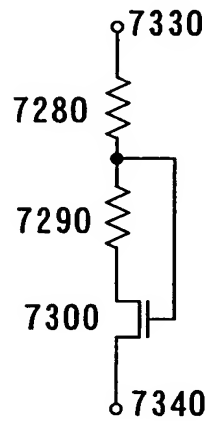
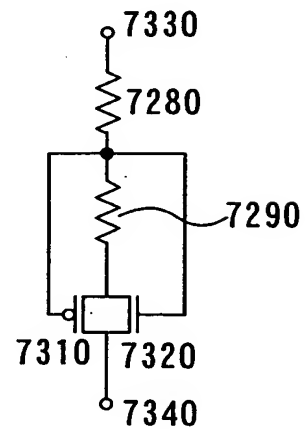
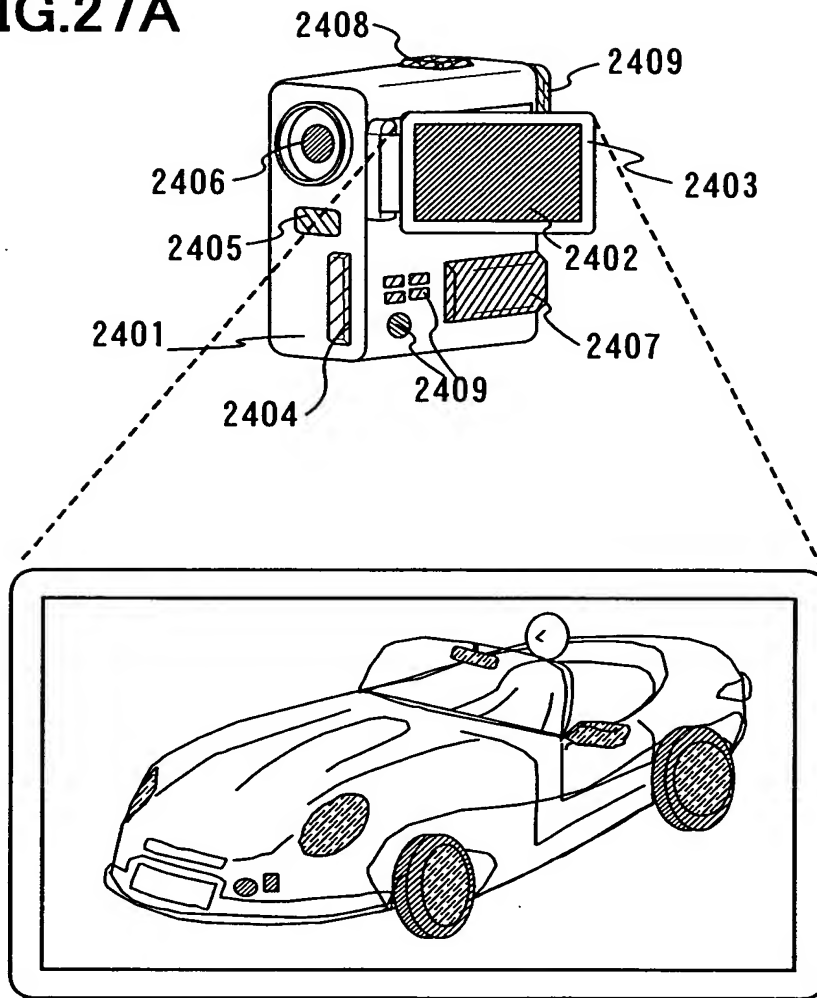
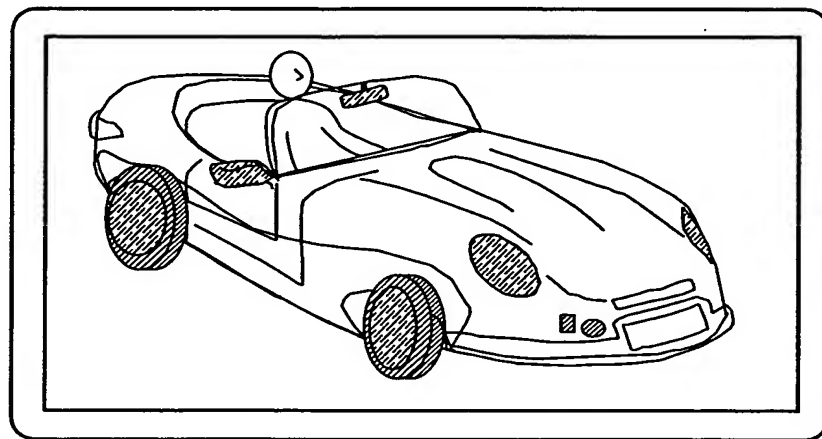
FIG.26A**FIG.26B****FIG.26C**

FIG.27A



**FIG.
27B**



EXPLANATION OF REFERENCE

100 substrate, 101 base film, 102 conductive layer, 103 conductive layer, 104 insulating
5 layer, 105 gate insulating layer, 106 conductive layer, 107 semiconductor layer, 108 N
type semiconductor layer, 109 channel protective film, 111 mask layer, 113 mask layer,
115 conductive layer, 116 conductive layer, 117 conductive layer, 118 through-hole, 120
insulating layer, 121 electroluminescent layer, 122 conductive layer, 140 conductive
material, 1400 substrate, 1403 droplet discharge means, 1404 imaging means, 1405
10 head, 1407 control means, 1408 storage medium, 1409 image processing means, 1410
computer
1411 marker, 150 sealing substrate, 151 sealant, 160 gate wiring layer, 1601 TFT, 1601
switching TFT, 1602 TFT, 1603 light emitting element, 1604 capacitor element, 1601
TFT, 1602 TFT, 1606 signal line, 1607 power supply line, 1605 scanning line, 1603
15 pixel electrode, 1604 capacitor element, 161 anisotropic conductive layer, 162 flexible
printed circuit board (FPC), 200 substrate, 2001 chassis, 2002 display panel, 2003 main
screen, 2004 modem, 2005 receiver, 2006 remote control unit, 2007 display portion,
2008 sub screen, 201 base film, 202 conductive layer, 203 conductive layer, 205 gate
insulating layer, 206 conductive layer, 207 semiconductor layer, 2101 main body, 2102
20 chassis, 2103 display portion, 2104 keyboard, 2105 external connection port, 2106
pointing mouse, 211 mask layer, 213 mask layer, 215 conductive layer, 216 conductive
layer, 217 conductive layer, 220 insulating layer, 2201 main body, 2202 chassis, 2203
display portion A, 2204 display portion B, 2206 operation key, 2207 speaker portion,
221 electroluminescent layer, 222 conductive layer, 230 conductive layer, 2301 main

body, 2302 audio output portion, 2303 audio input portion, 2304 display portion, 2305 operation switch, 2306 antenna, 231 conductive layer, 2401 main body, 2402 display portion, 2403 chassis, 2404 external connection port, 2405 remote control receiving portion, 2406 image receiving portion, 2407 battery, 2408 audio input portion, 2409 operation key, 300 substrate, 301 base film, 302 conductive layer, 303 conductive layer, 305 gate insulating layer, 306 conductive layer, 307 semiconductor layer, 308 N type semiconductor layer, 309 channel protective film, 311 mask layer, 313 mask layer, 315 conductive layer, 316 conductive layer, 317 conductive layer, 318 through-hole, 320 insulating layer, 321 electroluminescent layer, 322 conductive layer, 341 insulating layer, 450 substrate, 451 transistor, 452 source-drain wiring, 454 electrode, 455 electroluminescent layer, 456 electrode, 461 source-drain wiring, 462 wiring, 463 electrode, 464 electroluminescent layer, 465 electrode, 470 source-drain wiring, 472 electrode, 473 electroluminescent layer, 474 electrode, 500 substrate, 501 base film, 502 conductive layer, 503 conductive layer, 505 gate insulating layer, 506 conductive layer, 507 semiconductor layer, 508 N type semiconductor layer, 511 mask layer, 513 mask layer, 515 conductive layer, 516 conductive layer, 517 conductive layer, 518 through hole, 520 insulating layer, 521 electroluminescent layer, 522 conductive layer, 6101 pixel, 6102 pixel portion, 6103 protection circuit, 6104 driver IC, 6107 driver IC, 6110 TFT, 6100 substrate, 6111 TFT, 6112 capacitor element, 6113 light emitting element, 6114 signal line, 6115 power supply line, 6116 scanning line, 6118 TFT, 6119 scanning line, 6125 TFT, 6126 TFT, 6127 wiring, 700 substrate, 750 substrate, 701 base film, 7250 resistor element, 751 pixel portion, 752 sealant, 702 conductive layer, 753 opposing substrate, 703 conductive layer, 754a FPC, 754b FPC, 754c FPC, 755a driver IC, 755b driver IC, 705 gate insulating layer, 706 conductive layer, 756a FPC,

756b FPC, 757a driver IC, 757b driver IC, 757c driver IC, 707 semiconductor layer, 708 N type semiconductor layer, 711 mask layer, 7121 capacitor element, 7122 P type TFT, 7122 TFT, 7123 TFT, 7126 diode, 7128 resistor element, 713 mask layer, 7130 transistor, 715 conductive layer, 716 conductive layer, 717 conductive layer, 718 through-hole, 720 insulating layer, 721 electroluminescent layer, 7210 capacitor element, 722 conductive layer, 7220 P type TFT, 7250 resistor element, 7280 resistor element, 7300 N type TFT, 7310 P type TFT, 7320 N type TFT, 7330 terminal, 7350 TFT, 804 tuner, 805 video signal amplifier circuit, 807 control circuit, 808 signal crossover network, 809 audio signal amplifier circuit, 810 audio signal processing circuit, 811 control circuit, 812 input portion, 813 speaker, 821 display screen, 822 speaker, 824 operation switch, 900 substrate, 901 base film, 902 gate electrode layer, 903 gate electrode layer, 905 gate insulating layer, 906 conductive layer, 907 semiconductor layer, 911 mask layer, 913 mask layer, 915, conductive layer, 916 conductive layer, 917 conductive layer, 917 conductive layer, insulating layer, 920 insulating layer, 921 electroluminescent layer, 922 conductive layer, 930 conductive layer, 931 conductive layer.